Taiwan Semiconductor



1A, 200V- 1000V Standard Bridge Rectifier

FEATURES

- AEC-Q101 qualified available
- Glass passivated chip junction
- Ideal for automated placement
- · Reliable low cost construction utilizing molded plastic technique
- High surge current capability
- UL Recognized File # E-326854
- Moisture sensitivity level: level 1, per J-STD-020
- RoHS Compliant
- Halogen-free according to IEC 61249-2-21

APPLICATIONS

- Switching mode power supply (SMPS)
- Adapters
- Lighting application

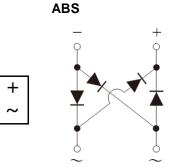
MECHANICAL DATA

- Case: ABS
- Molding compound meets UL 94V-0 flammability rating
- Terminal: Matte tin plated leads, solderable per J-STD-002
- Meet JESD 201 class 2 whisker test
- Polarity: As marked
- Weight: 0.120g (approximately)

KEY PARAMETERS			
PARAMETER	VALUE	UNIT	
١ _F	1	А	
V _{RRM}	200 - 1000	V	
I _{FSM}	30	А	
T _{J MAX}	150	°C	
Package	ABS		
Configuration	Quad		







ABSOLUTE MAXIMUM RATINGS (T _A = 25°C unless otherwise noted)								
PARAMETER		SYMBOL	ABS2	ABS4	ABS6	ABS8	ABS10	UNIT
Marking code on the	e device		ABS2	ABS4	ABS6	ABS8	ABS10	
Repetitive peak reve	erse voltage	V _{RRM}	200	400	600	800	1000	V
Reverse voltage, total rms value		V _{R(RMS)}	140	280	420	560	700	V
Forward current	On glass-epoxy	I _F	0.8			Α		
	On aluminum substrate		1.0				Α	
Peak forward surge current, 8.3ms single half sine-wave superimposed on rated load		I _{FSM}	30			Α		
Rating for fusing (t<8.3ms)		l ² t	3.74				A ² s	
Junction temperature		TJ	- 55 to +150				°C	
Storage temperature		T _{STG}	- 55 to +150				°C	



THERMAL PERFORMANCE				
PARAMETER	SYMBOL	ТҮР	UNIT	
Junction-to-lead thermal resistance	R _{eJL}	25	°C/W	
Junction-to-ambient thermal resistance	R _{eja}	80	°C/W	

ELECTRICAL SPECIFICATIONS (T _A = 25°C unless otherwise noted)					
PARAMETER	CONDITIONS	SYMBOL	ТҮР	MAX	UNIT
Forward voltage per diode ⁽¹⁾	$I_F = 0.4A, T_J = 25^{\circ}C$	V _F	-	0.95	V
Powerse surrent @ roted \/_per diado ⁽²⁾	T _J = 25°C	I _R	-	10	μA
Reverse current @ rated V_R per diode ⁽²⁾	T _J = 125°C		-	150	μA

Notes:

1. Pulse test with PW = 0.3ms

2. Pulse test with PW = 30ms

ORDERING INFORMATION			
ORDERING CODE ⁽¹⁾⁽²⁾	PACKAGE	PACKING	
ABSx	ABS	5,000 / Tape & Reel	
ABSxH	ABS	5,000 / Tape & Reel	

Notes:

1. "x" defines voltage from 200V(ABS2) to 1000V(ABS10)

2. "H" means AEC-Q101 qualified



CHARACTERISTICS CURVES

 $(T_A = 25^{\circ}C \text{ unless otherwise noted})$

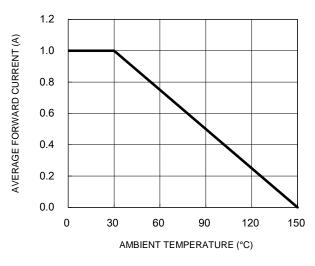


Fig.1 Forward Current Derating Curve

Fig.3 Typical Reverse Characteristics

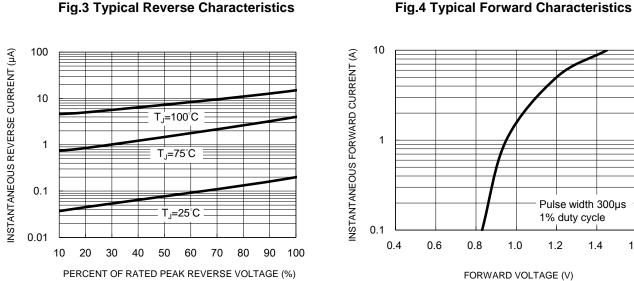


Fig.5 Maximum Non-Repetitive Forward Surge Current

1000

100

10

0.1

11111

1

f=1.0MHz Vsig=50mVp-p

CAPACITANCE (pF)

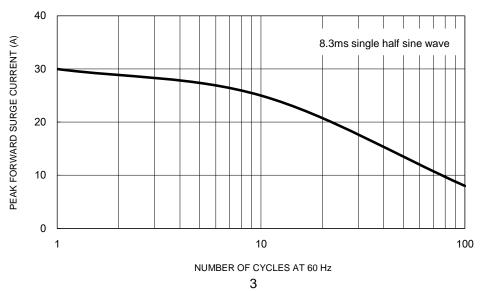


Fig.2 Typical Junction Capacitance

10

REVERSE VOLTAGE (V)

100

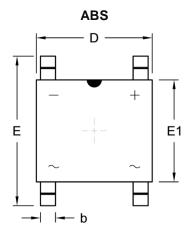
1000

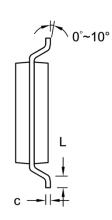
1.6

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PACKAGE OUTLINE DIMENSIONS



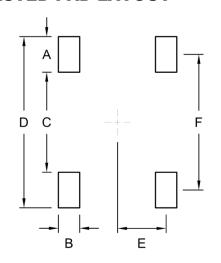


DIM.	Unit (mm)		Unit (inch)		
	Min.	Max.	Min.	Max.	
А	1.40	1.60	0.055	0.063	
A1	0.05	0.15	0.002	0.006	
A2	1.35	1.45	0.053	0.057	
b	0.60	0.70	0.024	0.028	
с	0.15	0.25	0.006	0.010	
D	4.90	5.10	0.193	0.201	
E	6.25	6.65	0.246	0.262	
E1	4.30	4.50	0.169	0.177	
е	3.90	4.10	0.154	0.161	
L	0.30	0.70	0.012	0.028	



е

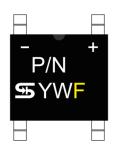
A



A2

Symbol	Unit (mm)	Unit (inch)
A	1.50	0.059
В	0.90	0.035
С	4.22	0.166
D	7.22	0.284
E	2.05	0.081
F	5.72	0.225

MARKING DIAGRAM



P/N	= Marking Code
YW	= Date Code

F = Factory Code



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